

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5541583

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	SECURITY INTEREST
CONVEYING PARTY DATA	
Name	Execution Date
TELFLEX TECHNOLOGIES INC.	05/23/2019
RECEIVING PARTY DATA	
Name:	BDC CAPITAL INC.
Street Address:	5, PLACE VILLE MARIE
Internal Address:	SUITE 500
City:	MONTREAL
State/Country:	CANADA
Postal Code:	H3B5E7
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	9479912
CORRESPONDENCE DATA	
Fax Number:	(514)845-9522
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	514 845 3533
Email:	couellet@morencyavocats.com
Correspondent Name:	MORENCY SOCIÉTÉ D'AVOCATS
Address Line 1:	500, PLACE D'ARMES
Address Line 2:	25TH FLOOR
Address Line 4:	MONTREAL, CANADA H2Y 2W2
NAME OF SUBMITTER:	CATHERINE OUELLET
SIGNATURE:	/Catherine Ouellet/
DATE SIGNED:	05/28/2019
Total Attachments: 1	
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CONFIRMATION OF SECURITY INTERESTS IN INTELLECTUAL PROPERTY

In consideration of a loan in the amount of one million dollars (\$ 1,000,000.00) granted by **BDC CAPITAL INC.**, whose head office is located at 5 Place Ville Marie, Suite 500, Montreal, Province of Quebec, H3B 5E7, (the "**Assignee**") in favour of Telflex Technologie inc. whose head office is located at 8165, du Mistral Street, Suite 201, Lévis, Province of Quebec, G6X 3R8, (the "**Assignor**") pursuant to a letter of offer of financing dated April 12, 2019, including its schedules and any amendments, as the case may be, the Assignor hereby confirms having granted to the Assignee, as of this date, hypothecary rights (security interests) in and to the following trademark and patent registrations:

TRADEMARKS

Trademark	Application Number	Registration Number
Base Camp Connect	8663599	5087522

PATENTS

Title	Application Number	Registration Number
Transportable telecommunication interconnection device	N/A	9,479,912

Signed in Lévis, this 23th day of May 2019.

TELFLEX TECHNOLOGIE INC.

By:  Jean-Philippe GRONDIN, President